



ENABLING

FLEXIBLE DISPLAY TECHNOLOGY

## Barix Multilayers: a Water and Oxygen Barrier for Flexible Organic Electronics

### **Robert Jan Visser**

Organic Electronics Is the Future of Electronics Organic? <u>MIT·Stanford·UC Berkeley Nano Forum</u>

Vitex Systems, Inc.

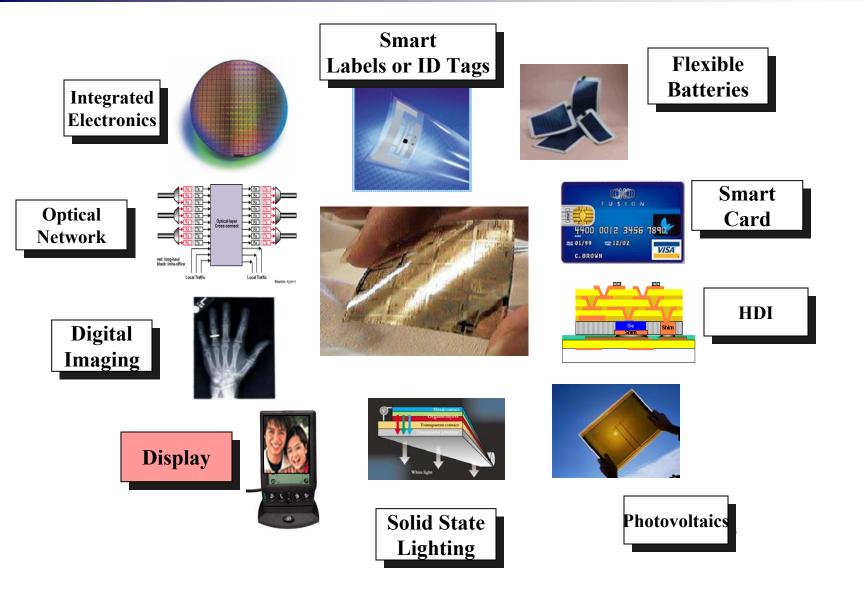
3047 Orchard Parkway San Jose, CA 95134 tel 408-519-4400 fax 408-519-4470 www.vitexsys.com



- There is not only an important future of electronics in organics, but much of that future will be **flexible** as well :
- Drivers:
  - Flexibility and form variety of applications
  - Thin, light weight and unbreakable
  - Cheaper materials
  - Large area, cheaper processes: R2R, printing techniques



# **Applications of Organic electronics**



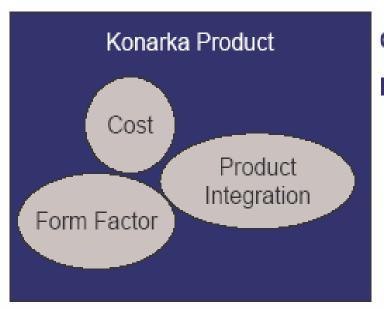


# Flexible OLED display (NHK)





# **Flexible Solar cells**



Cost: 1/3 of traditional solar

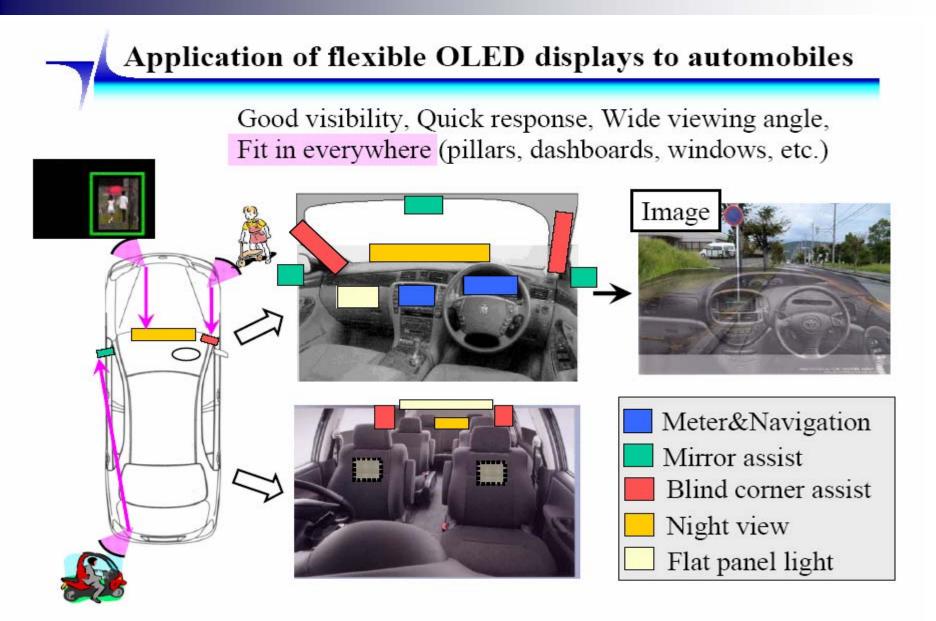
#### Form Factor:

Power to Weight- 10x of traditional solar Thickness- 100x thinner than traditional solar Flexibility- conformable to 2 cm diameter Aesthetic- patterns, images and colors

#### Product Integration:

Designed into devices systems, and structures







- Need low temperature processes: <100~200 C</p>
- Higher thermal expansion coefficient, lower dimensional stability then f.i. glass.
- Substrates are not flat and have many defects
- Plastics are highly permeable for water and oxygen and offer little protection for electronic components
- Barix multilayers offer a solution for the last two problems



 A typical plastic film has a permeability for water (WVTR) of 1~10 gr/m²/day

# WVTR Needed for ~10 yr device lifetime:

- Organic LED
- Solar Cells
- LCD
- Electroforetic displays
- RFID tags

**10<sup>-6</sup> gr/m<sup>2</sup>/day** 10<sup>-4</sup> gr/m<sup>2</sup>/day 10<sup>-3</sup> gr/m<sup>2</sup>/day 10<sup>-2</sup> gr/m<sup>2</sup>/day

 Permeabilities and requirements for Oxygen are very similar



# **Barix™ Multilayer Encapsulation**

## Multilayer

- Redundancy
- Tortuosity

## Organic/Inorganic

• Organic:

planarization/smoothing

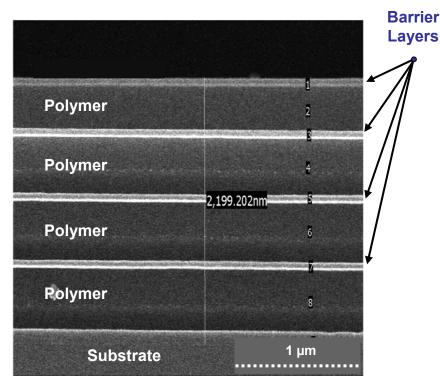
 Inorganic: barrier to H<sub>2</sub>O and O<sub>2</sub> penetration

## Transparent

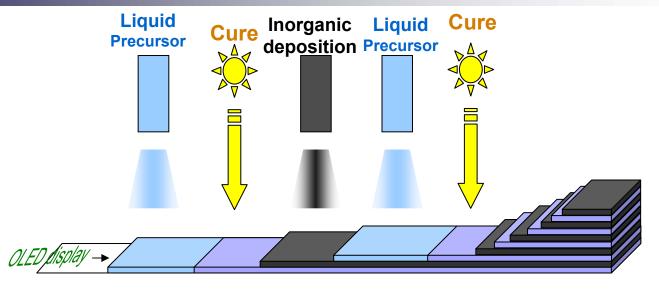
- Suitable for top-emitter
- Flexible substrates

## Low Temperature:

 Suitable for organic electronics



# **Barix™ Multilayer Deposition**



#### Inorganic:

•Aluminum oxide deposited by DC reactive sputtering

•Thickness 30-100 nm

#### •Organic:

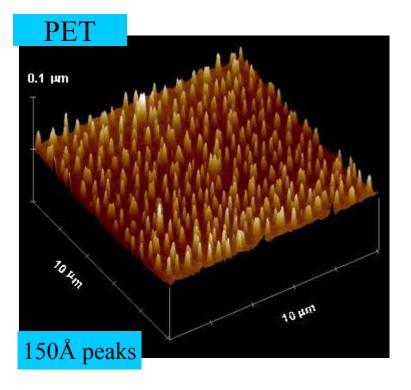
- •Monomer mixture deposited in vacuum
- •Non-conformal deposition: Liquid-Vapor-Liquid- (UV curing)-Solid
- •Thickness 0.25 several  $\mu m$

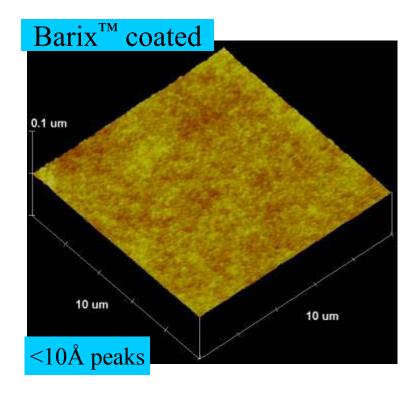
•4-5 polymer / inorganic pairs (dyads) for encapsulation



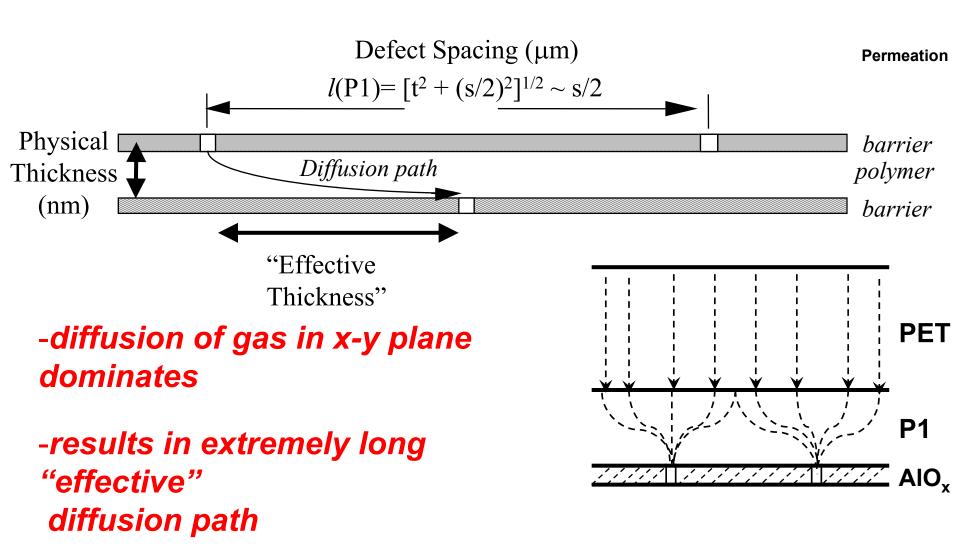
# **Creating defect free surfaces**

### Atomic force Microscope reveals defect sites are eliminated

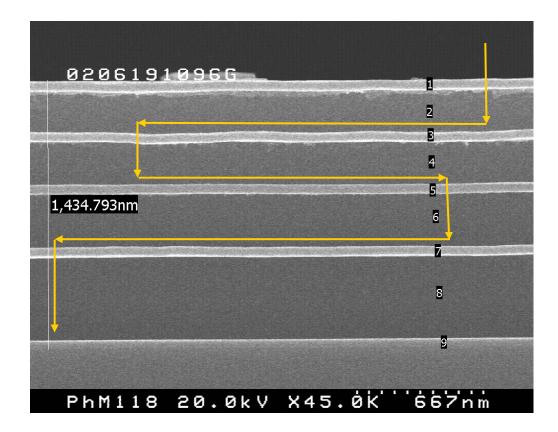












Extremely long "Effective" diffusion path length due to large spacing between defects in AlOx layers



# Vitex's Path

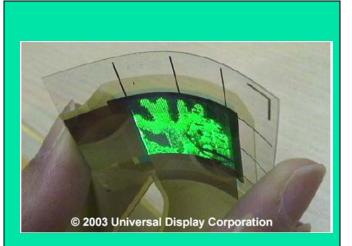
### Today



#### Encapsulation process of rigid OLED displays



Transparent barrier substrate for flexible displays Tomorrow



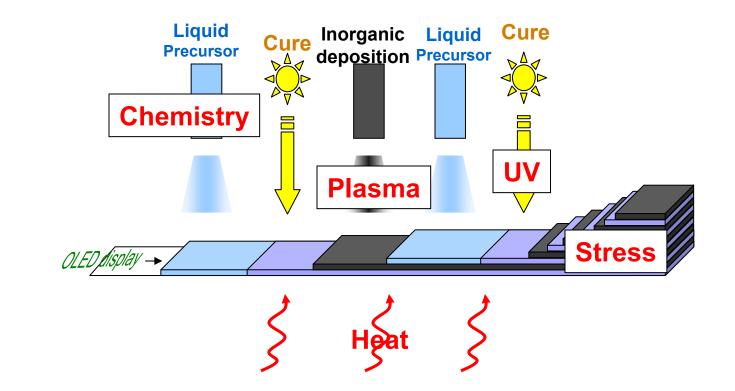
Full substrate/packaging solution for flexible plastic displays



# Encapsulation of OLED displays on a glass substrate

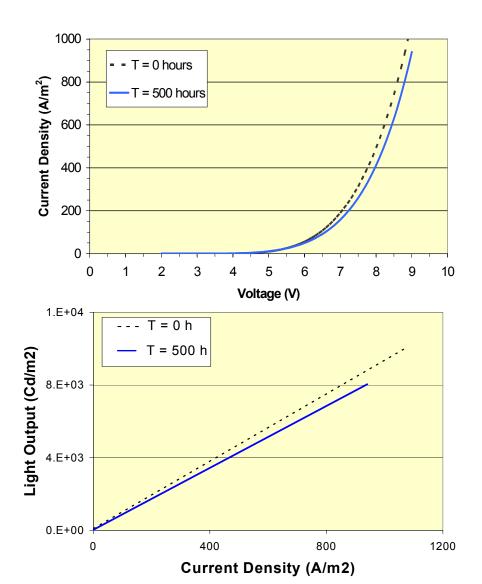
Status: Barrier layers on OLED displays meet telecommunication requirements

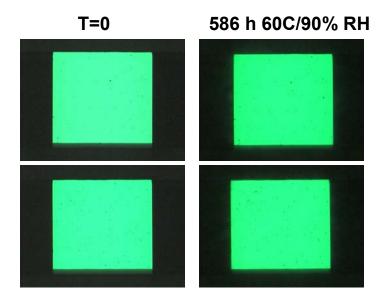
# **Compatibility of the process with devices**



- Many potential sources of damage
- With the right type of chemistry and process conditions they can be overcome

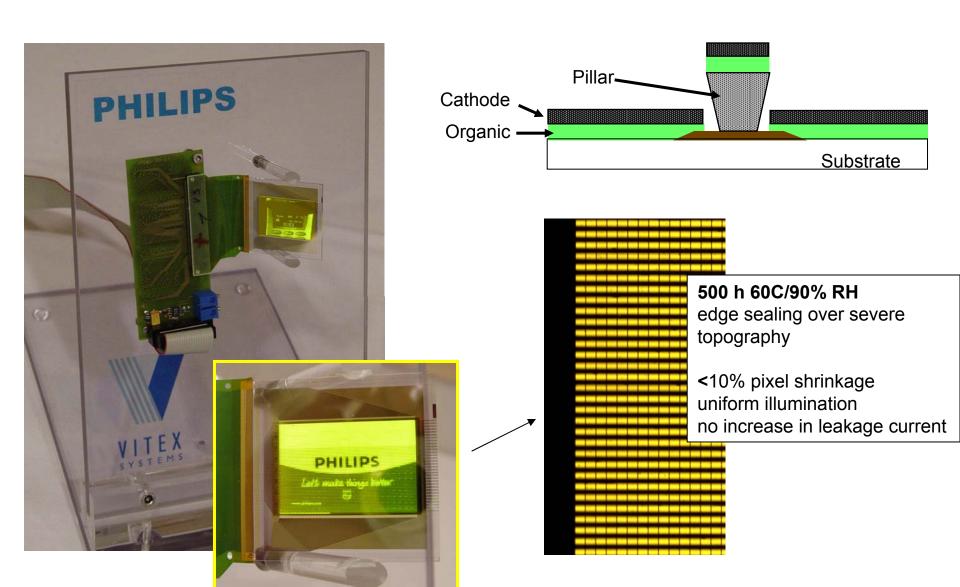
## Encapsulation of Bottom Emission Test Pixels on Glass



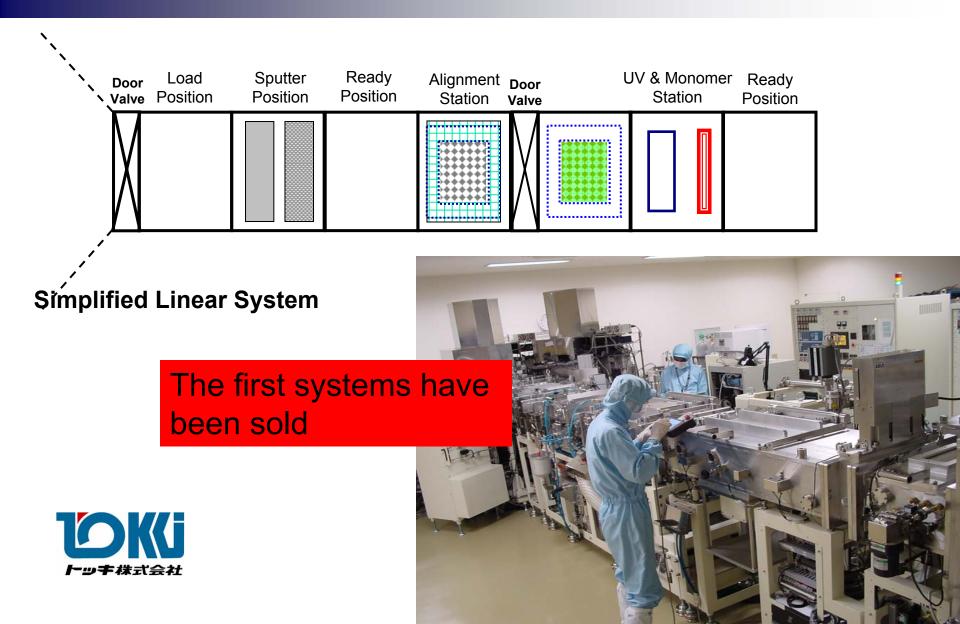


Pass requirements for 60C/90% RH, passive, 500 h 80 C, passive, 500 h -40 to +80 200 cycles 80C, 100 h energized

### Encapsulation of Passive Matrix Displays on Glass: Edge Seal



# Guardian System – Linear Tool for R&D



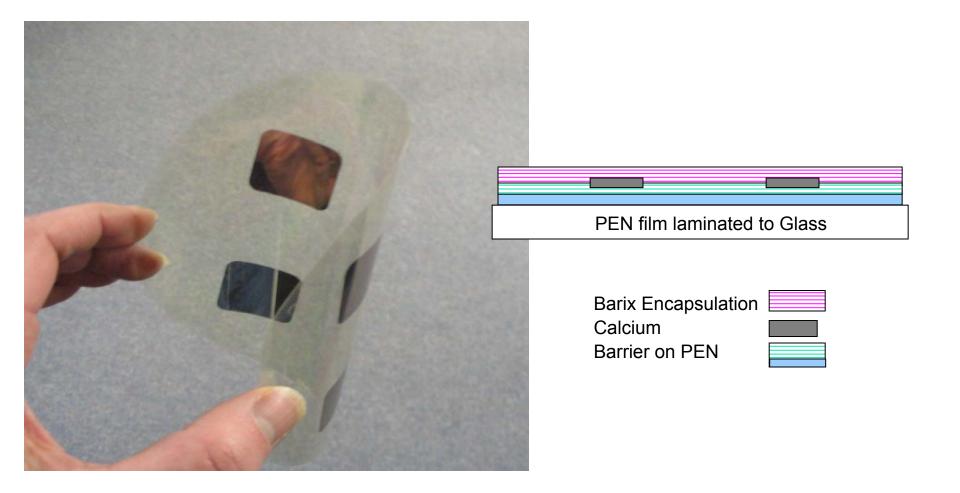


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# **Flexible Devices**

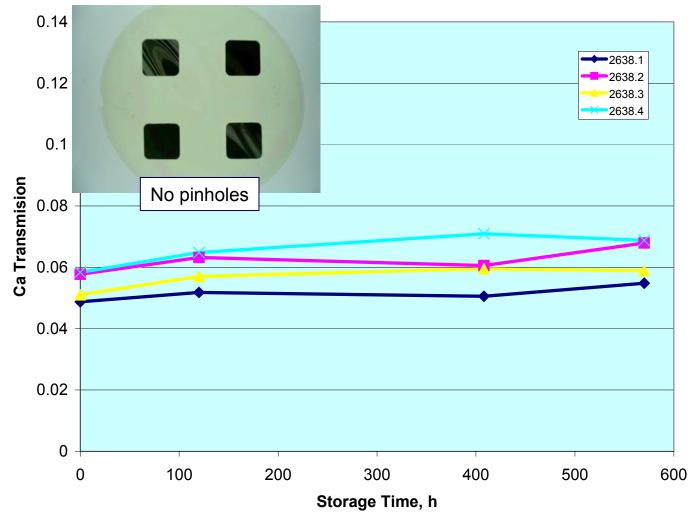


#### Ca buttons can be used to test barrier performance





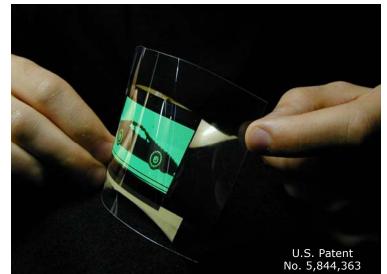
#### Almost no change after 570 h 60C 90% RH!



Permeation rate of ~1x10<sup>-6</sup> for the combination of encapsulant and barrier substrate at 21C

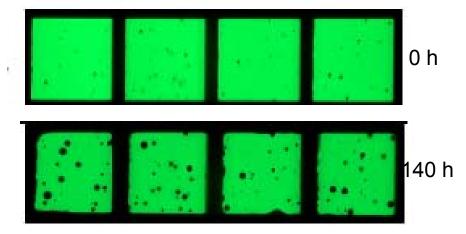


### Encapsulation of Plastic pixels and PM Displays





#### 60C/ 85% RH Shelf test

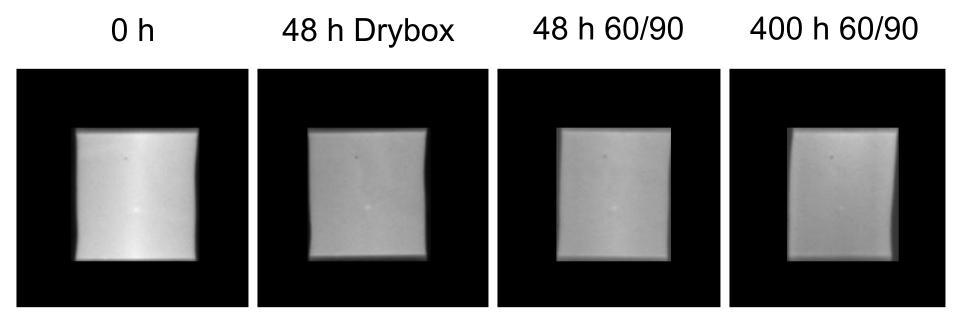


Chwang, et.al. Appl. Phys. Lett. (2003), 83 (3), 413-415

#### RT Lifetime on plastic is ok

Acceleration at higher T/ RH show poorer performance than on glass





PLED Test Pixels. No black spot growth!

Champion data: a lot of know how about processing on plastics needs to be developed



# **Examples of flexible OLED displays**

# Mono-color display Passive display

### First products expected in 2006



Dupont











Color display Pioneer



## **Flexible Substrate R2R Pilot Line**

- Large scale manufacturing of plastic barrier substrate.
- Process Control and Process Improvement remain key focal points
- Continue analysis to identify failure modes:
  - Mechanical abrasion
  - Impact of particles
  - Sources of particles

Co-operation with TMI (CT)





# Conclusions

- Barix thin film encapsulation can meet requirements for OLED's in telecom applications
- Vitex Encapsulation tools are entering the market
- Barix multilayers successfully solves two problems of plastic substrates:
  - Provide a microscopically flat surface
  - Protection of devices against the environment
- Flexible Organic Electronics is just around the corner



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